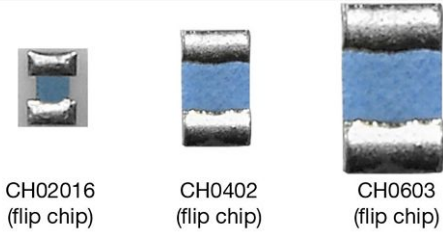


# High Frequency 50 GHz Thin Film Chip Resistor


 CH02016  
(flip chip)

 CH0402  
(flip chip)

 CH0603  
(flip chip)

**DESIGN SUPPORT TOOLS**
[click logo to get started](#)


Those miniaturized components are designed in such a way that their internal reactance is very small. When correctly mounted and utilized, they function as almost pure resistors on a very large range of frequency, up to 50 GHz.

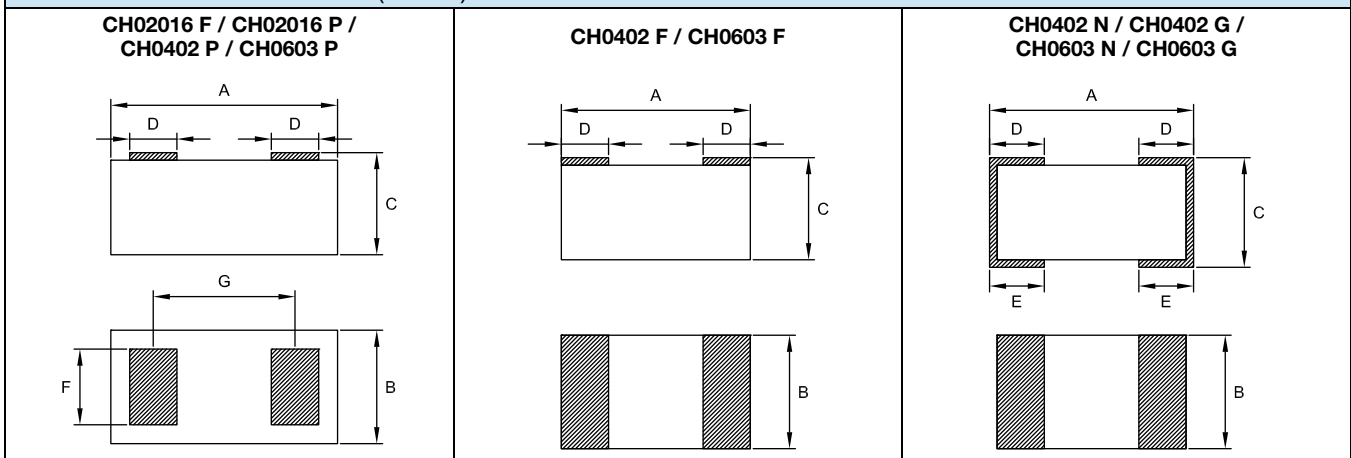
**FEATURES**

- Operating frequency 50 GHz
- Thin film microwave resistors
- Flip chip, wraparound or one face termination
- Small size, down to 20 mils by 16 mils
- Edged trimmed block resistors
- Pure alumina substrate (99.5 %)
- Ohmic range: 10R to 500R
- Design kits available
- Small internal reactance (LC down to  $1 \times 10^{-24}$ )
- Tolerance 1 %, 2 %, 5 %, 10 %
- TCR: 100 ppm/°C in (-55 °C, +155 °C) temperature range
- TCR: 50 ppm/°C available upon request for 10 Ω to 150 Ω ohmic range
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?999912](http://www.vishay.com/doc?999912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**  
**GREEN**  
 (5-2008)

**STANDARD ELECTRICAL SPECIFICATIONS**

MODEL	SIZE	RESISTANCE RANGE Ω	RATED POWER Pn W	LIMITING ELEMENT VOLTAGE V	TOLERANCE ± %	TEMPERATURE COEFFICIENT ± ppm/°C
CH02016	02016	10 to 500	0.030	30	2, 5, 10	100 (50 upon request)
CH0402	0402	10 to 500	0.050	37	1, 2, 5, 10	100 (50 upon request)
CH0603	0603	10 to 500	0.125	50	1, 2, 5, 10	100 (50 upon request)

**DIMENSIONS** in millimeters (inches)


CASE SIZE MODEL / TERMINATION	DIMENSIONS						
	± 0.10 (± 0.004)	± 0.10 (± 0.004)	± 0.127 (± 0.005)	D E when applicable		± 0.050 (± 0.002)	± 0.050 (± 0.002)
				MIN.	MAX.		
CH02016 F CH02016 P	0.480 (0.020)	0.390 (0.016)	0.420 (0.016) <sup>(1)</sup>	0.110 (0.004)	0.150 (0.006)	0.260 (0.010)	0.300 (0.012)
CH0402 F CH0402 N CH0402 G	1.000 (0.040)	0.600 (0.023)	0.500 (0.020)	0.150 (0.006)	0.350 (0.014)	n/a	n/a
CH0402 P	1.200 (0.047)	0.600 (0.023)	0.500 (0.020)	0.110 (0.004)	0.150 (0.006)	0.320 (0.013)	0.880 (0.035)
CH0603 F CH0603 N CH0603 G	1.520 (0.060)	0.750 (0.030)	0.500 (0.020)	0.250 (0.010)	0.510 (0.020)	n/a	n/a
CH0603 P	1.720 (0.068)	0.750 (0.030)	0.500 (0.020)	0.235 (0.009)	0.275 (0.011)	0.660 (0.026)	1.355 (0.053)

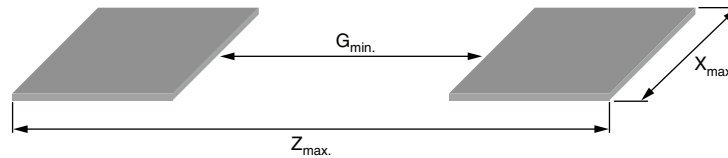
**Note**
<sup>(1)</sup> ± 0.070 (± 0.003)

**TOLERANCE VS. OHMIC VALUES**

Ohmic range	$10 \Omega \leq R < 50 \Omega$	$50 \Omega \leq R < 100 \Omega$	$100 \Omega \leq R \leq 500 \Omega$
Tolerance	5 %, 10 %	2 %, 5 %, 10 %	1 %, 2 %, 5 %, 10 % <sup>(1)</sup>

**Note**

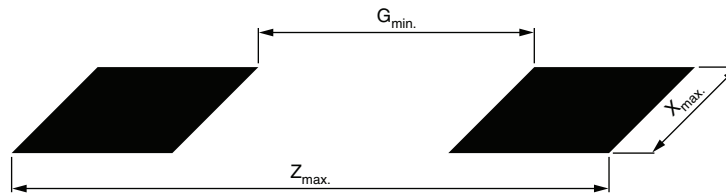
<sup>(1)</sup> 1 % tolerance not applicable for case 02016

**LAND PATTERN FOR F 'FLIP CHIP' TERMINATIONS** in millimeters (inches)


CHIP SIZE	$Z_{max.}$	$X_{max.}$	$G_{min.}$
02016	0.53 (0.021)	0.44 (0.017)	0.15 (0.006)
0402	1.40 (0.055)	0.65 (0.026)	0.40 (0.016)
0603	1.71 (0.067)	0.90 (0.035)	0.76 (0.030)

**Note**

- Suggested land pattern: According to IPC-7351

**LAND PATTERN FOR N AND G WRAPAROUND TERMINATIONS** in millimeters (inches)


CHIP SIZE	$Z_{max.}$	$G_{min.}$	$X_{max.}$
0402	1.55 (0.061)	0.15 (0.006)	0.73 (0.029)
0603	2.37 (0.093)	0.35 (0.014)	0.98 (0.039)

Dimension and tolerance of land pattern shall be defined by PCB designer; PCB can be designed according to IPC-7351A "Generic Requirements for Surface Mount Design and Land Pattern Standard"



**PREFERRED MODELS AND VALUES**

Vishay Sfernice highly recommend to use the smallest sizes and flip chip version to get the best performances.

Recommended Values:

10R/18R/25R/50R/75R/100R/150R/180R/200R/250R/330R/500R

Those values are available with a **MOQ of 100 pieces.**

**Other values can be ordered upon request, but higher MOQ will apply: 1000 pieces for CH02016, 500 pieces for CH0402, 50 pieces for CH0603.**

Recommended termination:

F

Recommended tolerance:

2 %

**DESIGN KITS**

Design kits are available Ex Stock in CH02016 and CH0402 sizes. There are 20 pieces per recommended value. F termination. 5 % tolerance.

Those kits are packaged in pieces of tape and delivered in ESD bags.

**PACKAGING**

Standard packaging is plastic tape and reel for all sizes.

Paper tape and reel is available for sizes 0402 and 0603.

Waffle pack is available for all sizes.

Depending on the type of terminations, parts will be packed differently:

One face:

- Gold terminations: (P termination option): active face up
- Tin / silver terminations: (F termination option): active face down in tape and reel  
active face up in waffle pack

**Note**

- Please refer to Vishay Sfernice Application Note "Guidelines for Vishay Sfernice Resistive and Inductive Products" for soldering recommendation (document number 52029, 3. Guidelines for Surface Mounting Components (SMD), profile number 3 applies

SIZE	MOQ	NUMBER OF PIECES PER PACKAGE		TAPE WIDTH	
		WAFFLE PACK 2" X 2"	TAPE AND REEL		
			Min.		Max.
02016	See MOQ mentioned on preferred models and values	484	100	5000	8 mm
0402		100			
0603		100			

**PACKAGING RULES**

**Waffle Pack**

Can be filled up to maximum quantity indicated in the table here above, taking into account the minimum order quantity. When quantity ordered exceeds maximum quantity of a single waffle pack, the waffle packs are stacked up on the top of each other and closed by one single cover. To get "not stacked up" waffle pack in case of ordered quantity > maximum number of pieces per package: Please consult Vishay Sfernice for specific ordering code.

**Tape and Reel**

See Part Numbering information to get the quantity desired by tape.

In regard to the CH02016 size only, up to 5 empty cavities can be found every 1000 parts in the reel. Nevertheless, the number of requested parts will be respected.



The complex impedance of the chip resistor is given by the following equations:

$$Z = \frac{R + j\omega(L - R^2C - L^2C\omega^2)}{1 + C[(R^2C - 2L)\omega^2 + L^2C\omega^4]}$$

$$\frac{[Z]}{R} = \frac{1}{1 + C[(R^2C - 2L)\omega^2 + L^2C\omega^4]} \times \sqrt{1 + \left[\frac{\omega(L - R^2C - L^2C\omega^2)}{R}\right]^2}$$

$$\theta = \tan^{-1} \frac{\omega(L - R^2C - L^2C\omega^2)}{R}$$

**Notes**

- $\omega = 2 \times \pi \times f$
- $f$ : Frequency

R, L and C are relevant to the chip resistor itself.

$L_c$  and  $C_g$  also depend on the way the chip resistor is mounted.

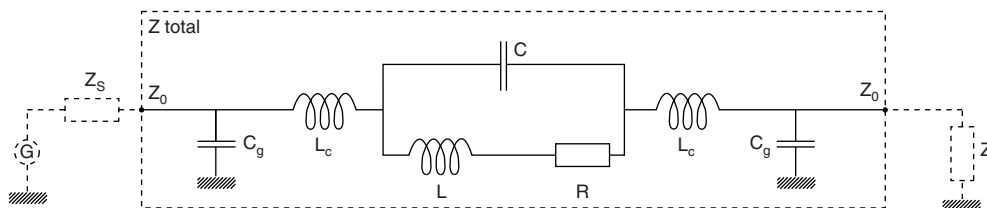
It is important to notice that after assembly the external reactance of  $L_c$  and  $C_g$  will be combined to internal reactance of L and C. This combination can upgrade or downgrade the HF behavior of the component.

This is why we are displaying three sets of data:

- $\frac{[Z]}{R}$  versus frequency curves which aim to show at a glance the intrinsic HF performance of a given chip resistor
- $\frac{[Z_{total}]}{R}$  versus frequency curves which aim to show the behavior of the chip resistor when mounted

These lines are terminated with adapted source and load impedance respectively  $Z_s$  and  $Z_l$  with  $Z_0 = Z_L = Z_s$  (for others configurations please consult us).

Equivalent circuit for S-parameters:

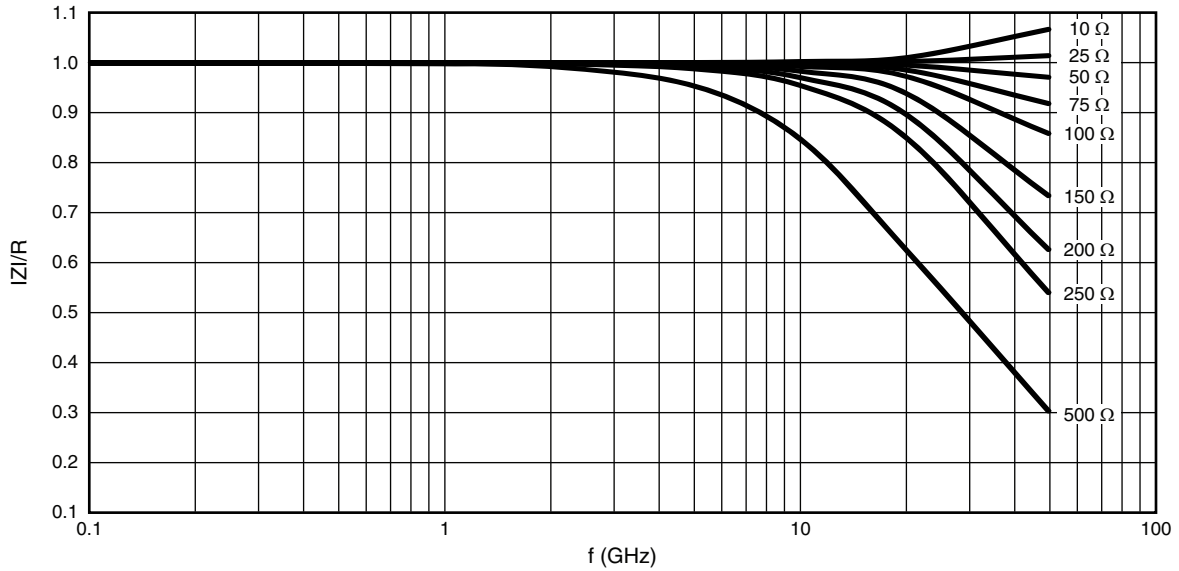


S-parameters are computed taking into account all the resistive, inductive and capacitive elements ( $Z_{total}$ ) and  $Z_0 = Z_L = Z_s = R$ .

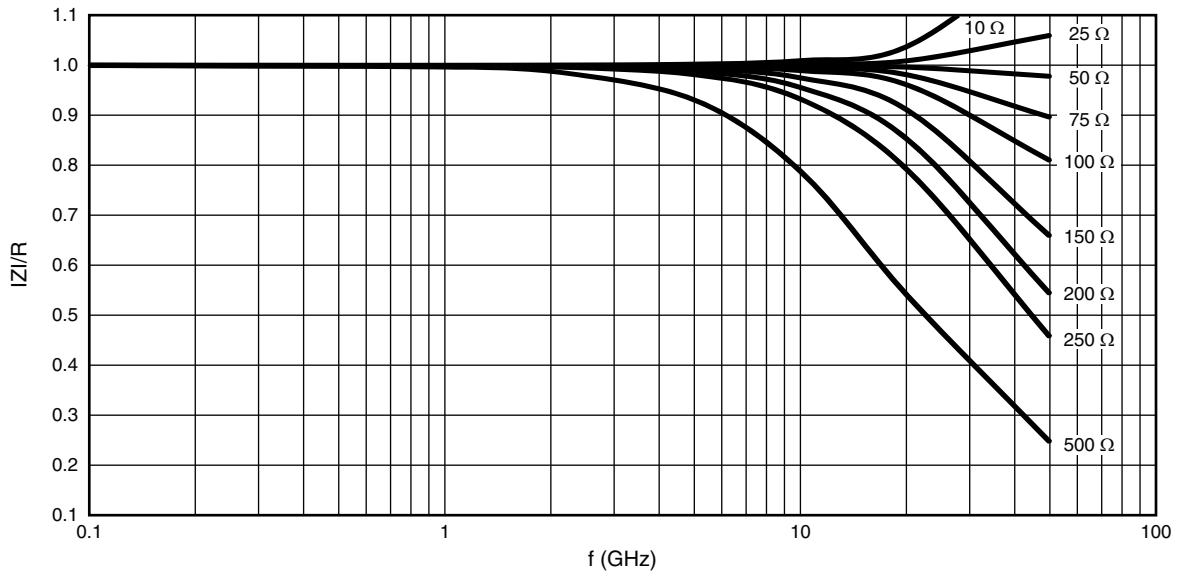
For simulation purposes, those S-parameter data are available for download here: [www.vishay.com/doc?53061](http://www.vishay.com/doc?53061)



### INTERNAL IMPEDANCE CURVES



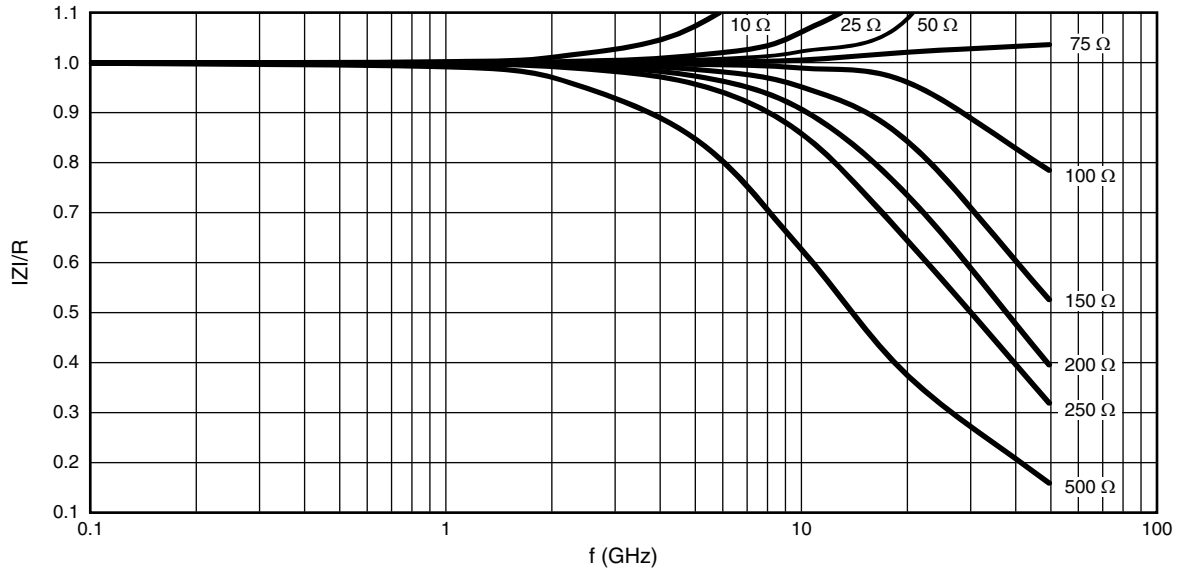
Internal impedance curve for 02016 size (F and P terminations)



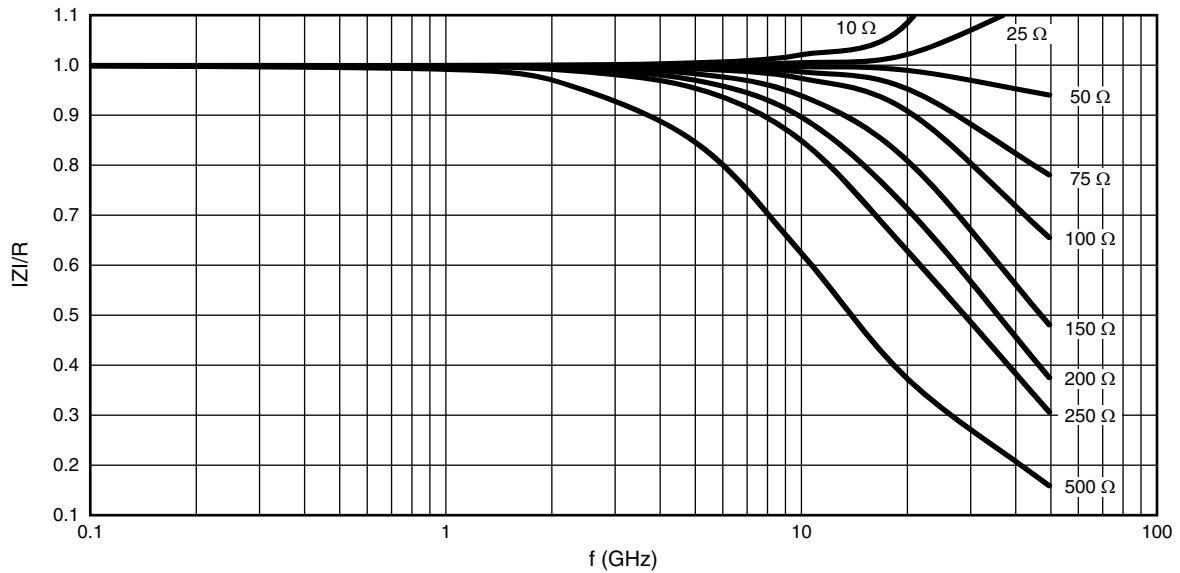
Internal impedance curve for 0402 size (F and P terminations)



### INTERNAL IMPEDANCE CURVES



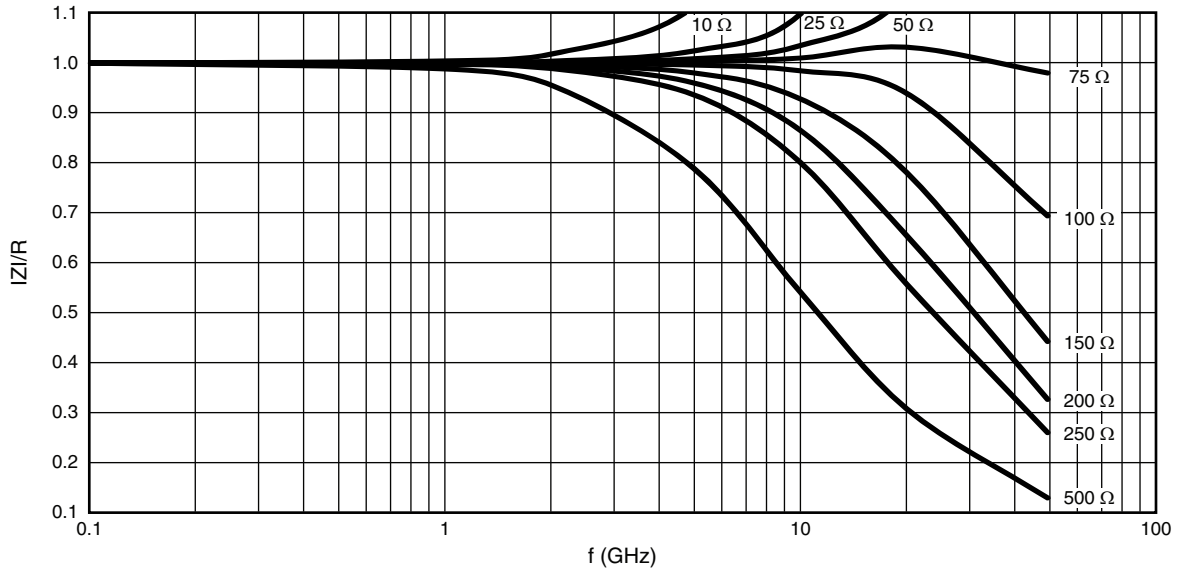
Internal impedance curve for 0402 size (N and G terminations)



Internal impedance curve for 0603 size (F and P terminations)

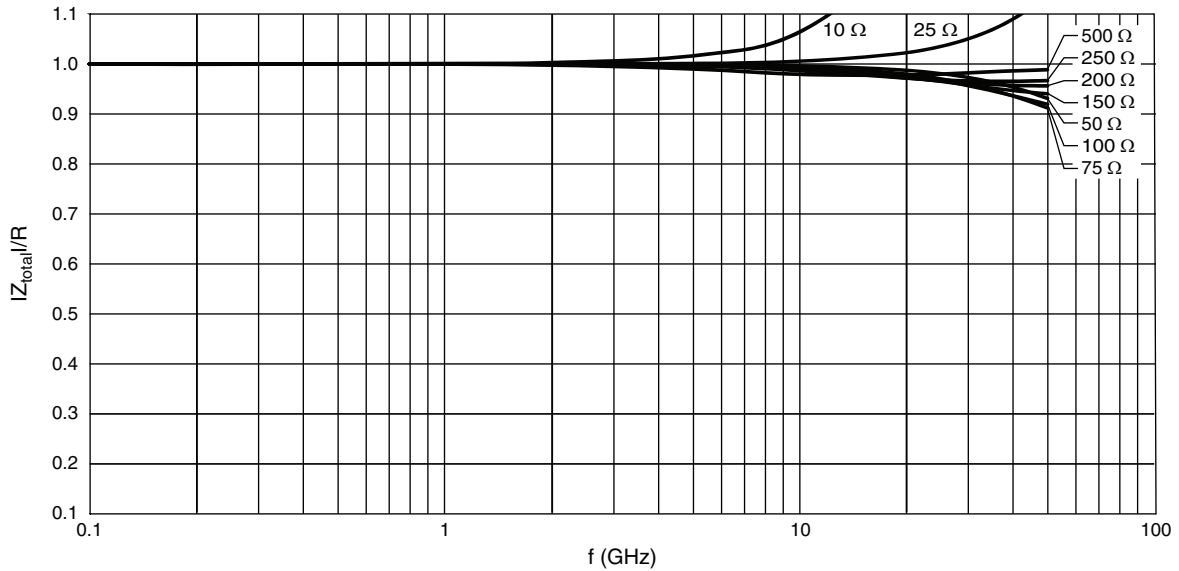


### INTERNAL IMPEDANCE CURVES



Internal impedance curve for 0603 size (N and G terminations)

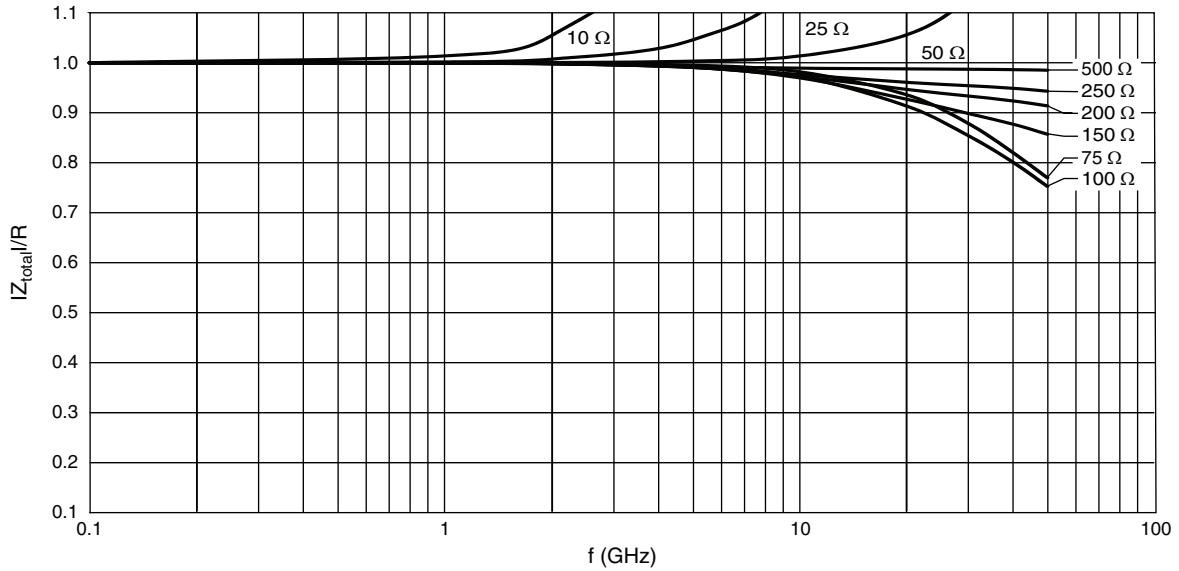
### INTERNAL IMPEDANCE CURVES ( $|Z_{TOTAL}| / R$ )



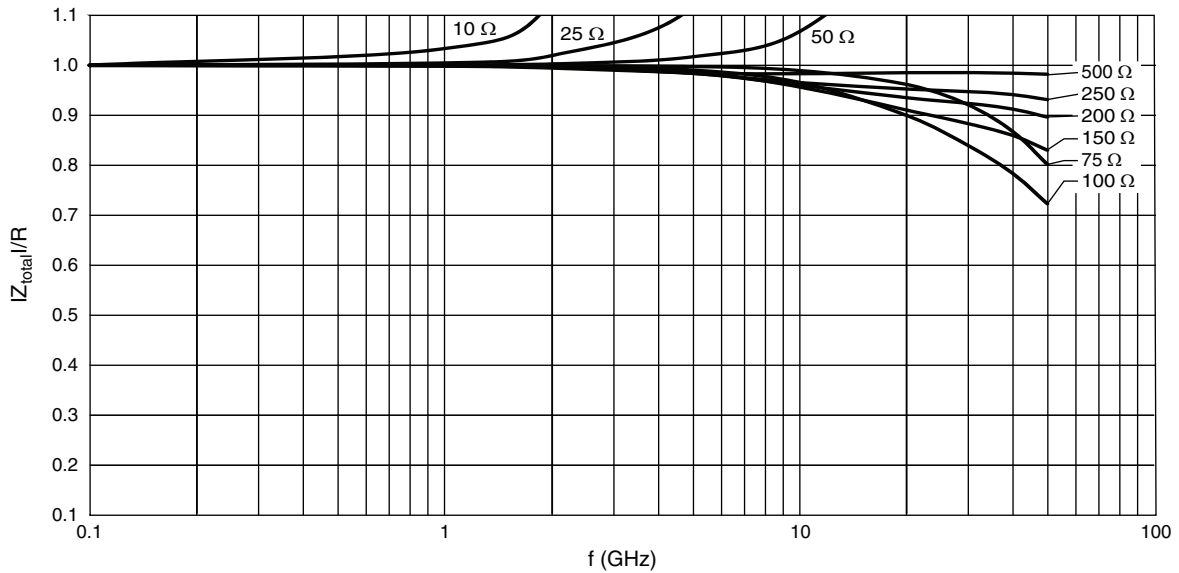
Internal impedance curve for 02016 size (F and P terminations)



**INTERNAL IMPEDANCE CURVES ( $|Z_{TOTAL}| / R$ )**



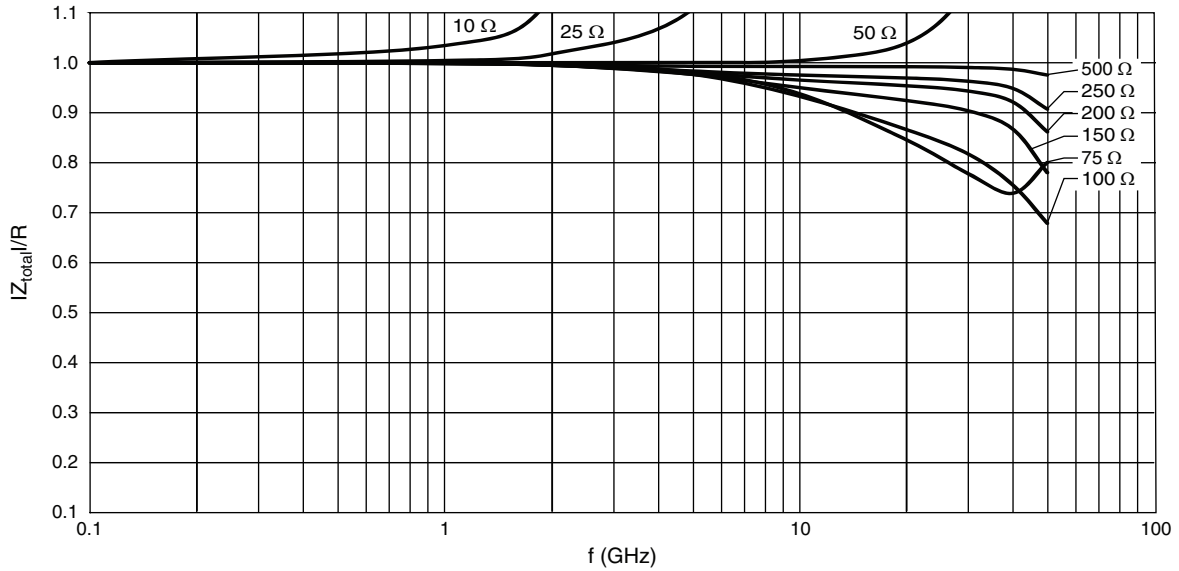
Internal impedance curve for 0402 size (F and P terminations)



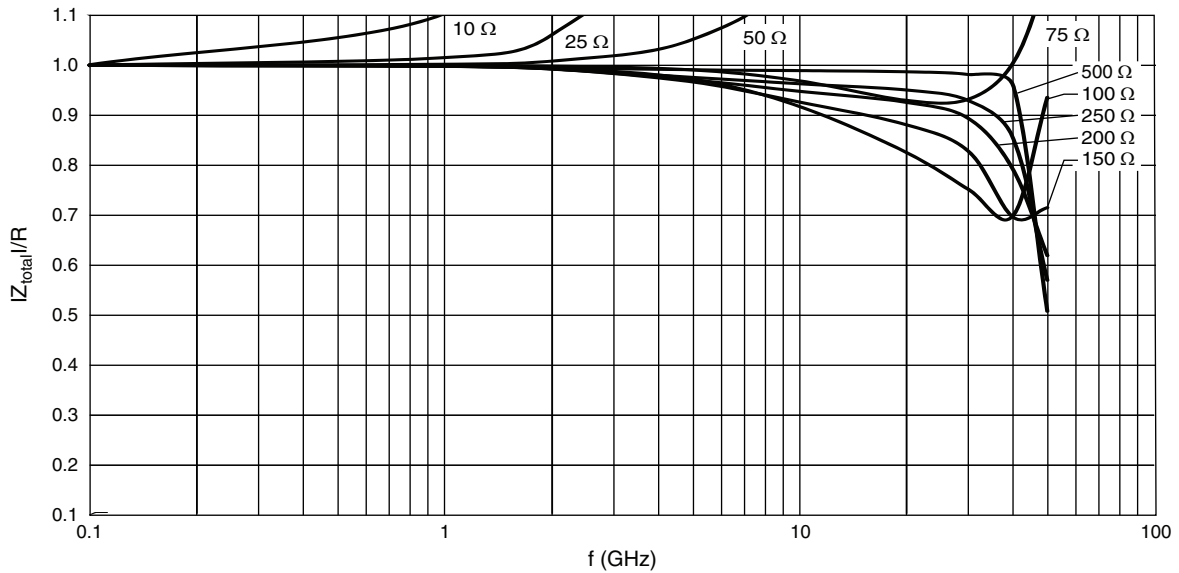
Internal impedance curve for 0402 size (N and G terminations)



### INTERNAL IMPEDANCE CURVES ( $|Z_{TOTAL}| / R$ )



Internal impedance curve for 0603 size (F and P terminations)

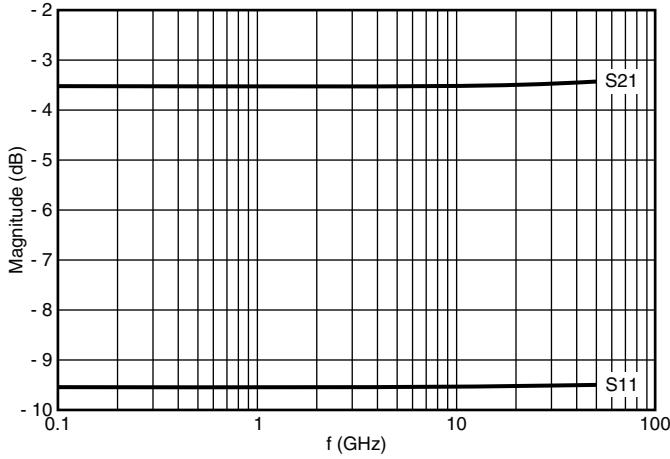


Internal impedance curve for 0603 size (N and G terminations)

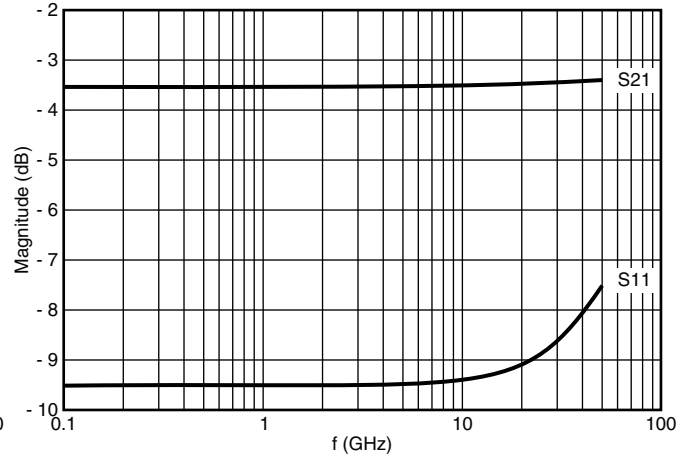


S-PARAMETER

CH02016 (F and P Terminations)

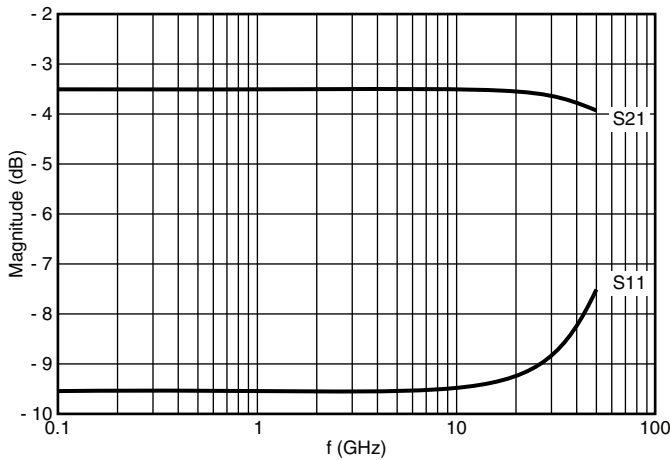


CH02016 flip chip ( $Z_0 = Z_1 = Z_s = R = 50 \Omega$ )

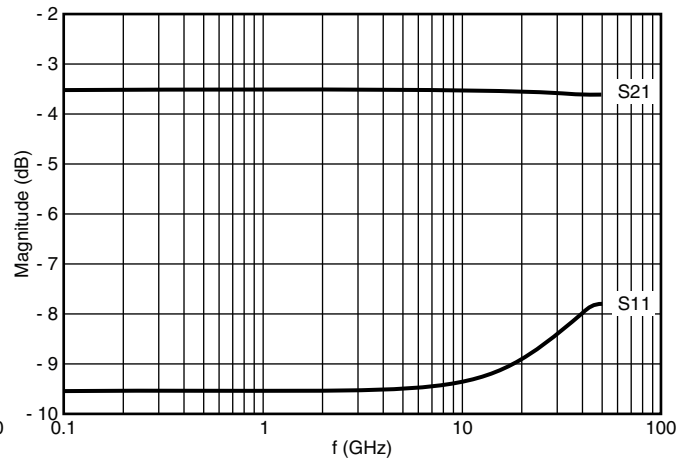


CH02016 flip chip ( $Z_0 = Z_1 = Z_s = R = 100 \Omega$ )

CH0402 (F and P Terminations)

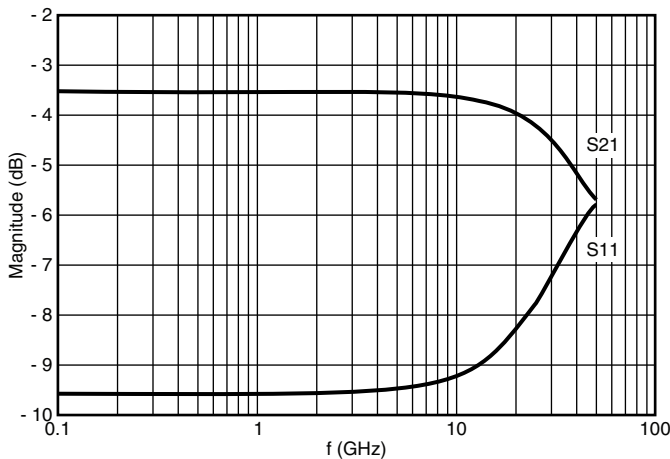


CH0402 flip chip ( $Z_0 = Z_1 = Z_s = R = 50 \Omega$ )

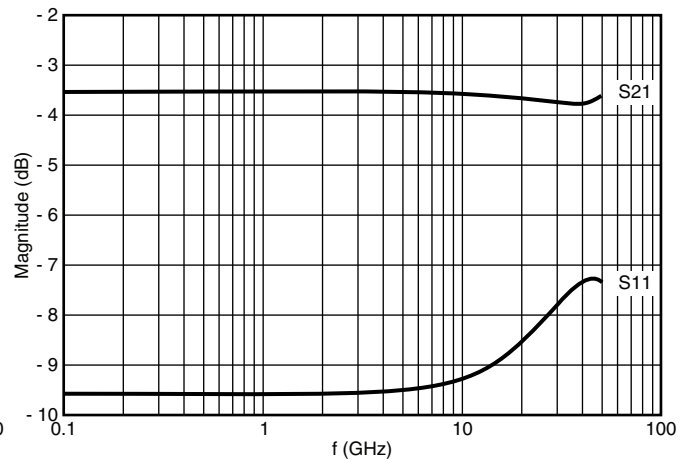


CH0402 flip chip ( $Z_0 = Z_1 = Z_s = R = 100 \Omega$ )

CH0402 (N and G Terminations)



CH0402 wraparound ( $Z_0 = Z_1 = Z_s = R = 50 \Omega$ )

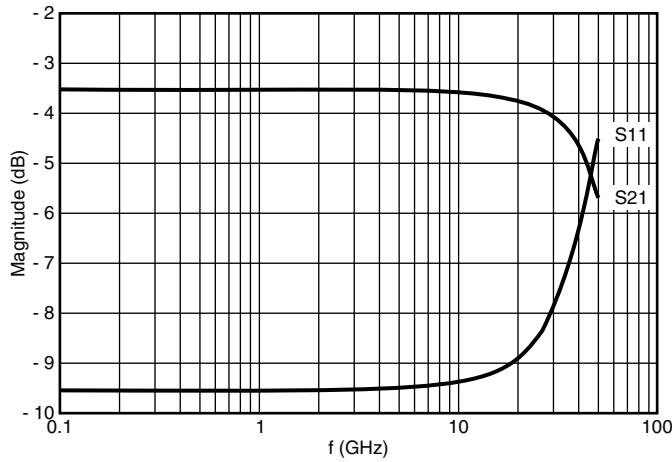


CH0402 wraparound ( $Z_0 = Z_1 = Z_s = R = 100 \Omega$ )

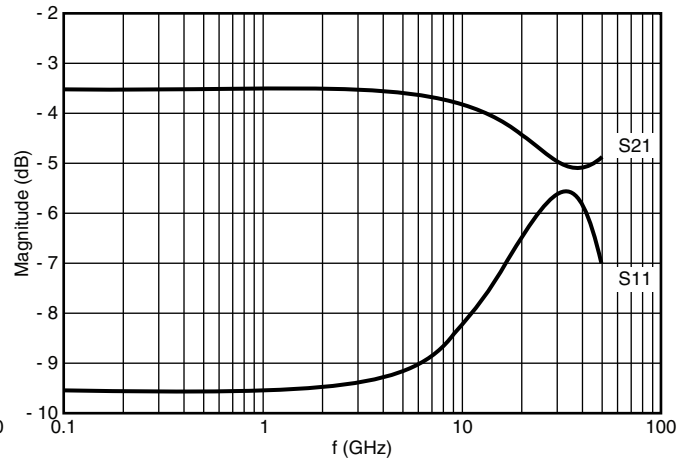


**S-PARAMETER**

**CH0603 (F and P Terminations)**

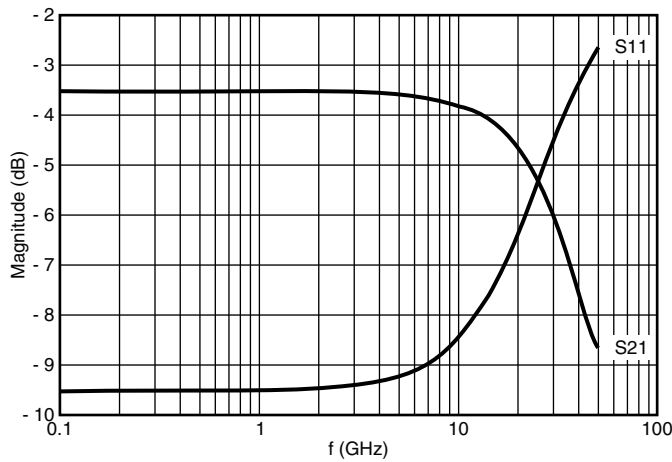


CH0603 flip chip ( $Z_0 = Z_1 = Z_s = R = 50 \Omega$ )

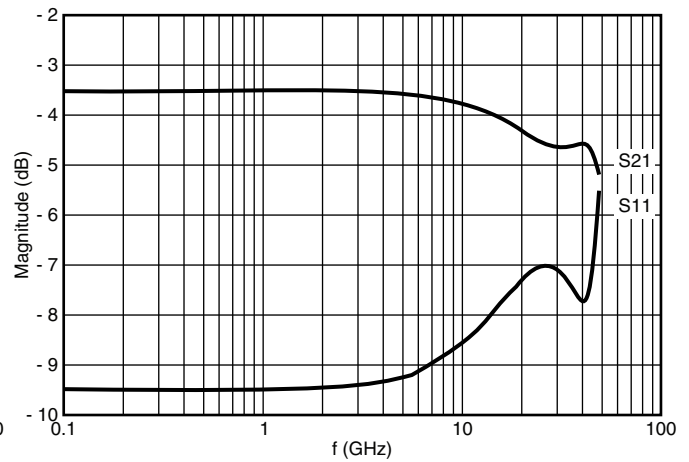


CH0603 flip chip ( $Z_0 = Z_1 = Z_s = R = 100 \Omega$ )

**CH0603 (N and G Terminations)**



CH0603 wraparound ( $Z_0 = Z_1 = Z_s = R = 50 \Omega$ )



CH0603 wraparound ( $Z_0 = Z_1 = Z_s = R = 100 \Omega$ )



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